KPTBD-3216SURKCGKC

3.2 x 1.6 mm SMD Chip LED Lamp



DESCRIPTIONS

- The Hyper Red source color devices are made with AlGaInP on GaAs substrate Light Emitting Diode
- The Green source color devices are made with AlGaInP on GaAs substrate Light Emitting Diode
- · Electrostatic discharge and power surge could damage the LEDs
- · It is recommended to use a wrist band or anti-electrostatic glove when handling the LEDs
- All devices, equipments and machineries must be electrically grounded

FEATURES

- 3.2 mm x 1.6 mm SMD LED, 1.8 mm thickness
- Low power consumption
- Ideal for backlight and indicator
- Package: 2000 pcs / reel
- Moisture sensitivity level: 3
- Halogen-free
- RoHS compliant

APPLICATIONS

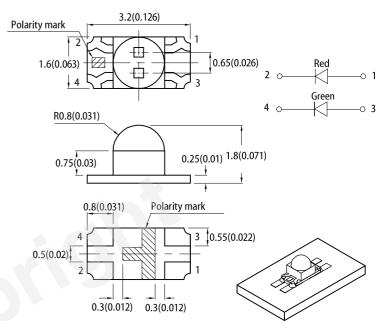
- Backlight
- Status indicator
- · Home and smart appliances
- · Wearable and portable devices
- · Healthcare applications

ATTENTION

Observe precautions for handling electrostatic discharge sensitive devices

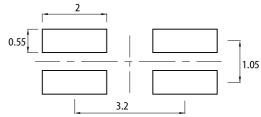


PACKAGE DIMENSIONS



RECOMMENDED SOLDERING PATTERN

(units : mm; tolerance : \pm 0.1)



All dimensions are in millimeters (inches).
Tolerance is ±0.2(0.008") unless otherwise noted.

3. The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.

The device has a single mounting surface. The device must be mounted according to the specifications.

SELECTION GUIDE

Part Number	Emitting Color (Material)	Lens Type	lv (mcd) @ 20mA ^[2]		Viewing Angle ^[1]
			Min.	Тур.	201/2
KPTBD-3216SURKCGKC		- Water Clear	700	1500	
	Hyper Red (AlGaInP)		*300	*600	30°
	Green (AlGaInP)		120	250	30
			*120	*250	

1. 61/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value. 2. Luminous intensity / luminous flux: +/-15%.

Luminous intensity / luminous flux: +/-15%. Luminous intensity value is traceable to CIE127-2007 standards

KPTBD-3216SURKCGKC

ELECTRICAL / OPTICAL CHARACTERISTICS at T_A=25°C

Parameter	Symbol	Emitting Color	Value		Unit
			Тур.	Max.	
Wavelength at Peak Emission I_F = 20mA	λ_{peak}	Hyper Red Green	645 574	-	nm
Dominant Wavelength $I_F = 20 \text{mA}$	λ _{dom} ^[1]	Hyper Red Green	630 570	-	nm
Spectral Bandwidth at 50% Φ REL MAX I _F = 20mA	Δλ	Hyper Red Green	28 20	-	nm
Capacitance	С	Hyper Red Green	35 15	-	pF
Forward Voltage $I_F = 20mA$	V _F ^[2]	Hyper Red Green	1.95 2.1	2.5 2.5	V
Reverse Current ($V_R = 5V$)	I _R	Hyper Red Green	-	10 10	μA
Temperature Coefficient of λ_{peak} I_F = 20mA, -10°C \leq T \leq 85°C	TC _{λpeak}	Hyper Red Green	0.14 0.12	-	nm/°C
Temperature Coefficient of λ_{dom} I_F = 20mA, -10°C \leq T \leq 85°C	TC _{λdom}	Hyper Red Green	0.05 0.08	-	nm/°C
Temperature Coefficient of V_F I_F = 20mA, -10°C \leq T \leq 85°C	TCv	Hyper Red Green	-1.9 -1.9	-	mV/°C

Notes:

The dominant wavelength (λd) above is the setup value of the sorting machine. (Tolerance λd : ±1nm.)
Forward voltage: ±0.1V.
Wavelength value is traceable to CIE127-2007 standards.
Excess driving current and / or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.

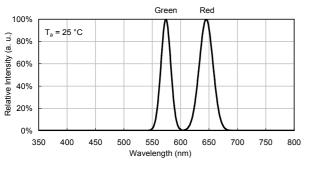
ABSOLUTE MAXIMUM RATINGS at T_A=25°C

Parameter	Symbol	Va	Unit	
, arameter	Cymbol	Hyper Red	Red Green	
Power Dissipation	P _D	75	75	mW
Reverse Voltage	V _R	5 5		V
Junction Temperature	TJ	115	115	°C
Operating Temperature	T _{op}	-40 T	°C	
Storage Temperature	T _{stg}	-40 T	°C	
DC Forward Current	I _F	30	30	mA
Peak Forward Current	I _{FM} ^[1]	185	150	mA
Electrostatic Discharge Threshold (HBM)	-	3000	3000	V
Thermal Resistance (Junction / Ambient)	R _{th JA} ^[2]	560	630	°C/W
Thermal Resistance (Junction / Solder point)	R _{th JS} ^[2]	430	500	°C/W

Notes: 1. 1/10 Duty Cycle, 0.1ms Pulse Width. 2. R_{th JA}, R_{th JS} Results from mounting on PC board FR4 (pad size ≥ 16 mm² per pad). 3. Relative humidity levels maintained between 40% and 60% in production area are recommended to avoid the build-up of static electricity – Ref JEDEC/JESD625-A and JEDEC/J-STD-033.

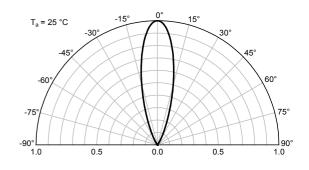
TECHNICAL DATA

RELATIVE INTENSITY vs. WAVELENGTH

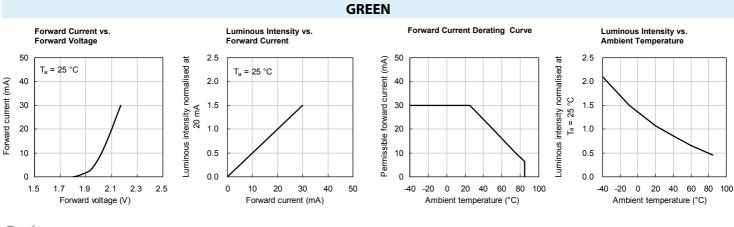


KPTBD-3216SURKCGKC

SPATIAL DISTRIBUTION



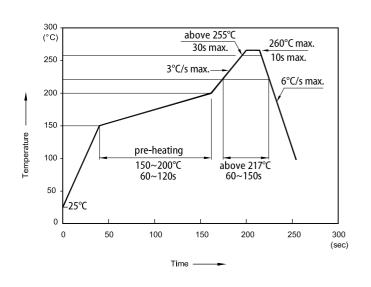
HYPER RED Forward Current Derating Curve Forward Current vs. Luminous Intensity vs. Luminous Intensity vs. Forward Voltage Forward Current Ambient Temperature 2.5 50 2.5 50 Luminous intensity normalised at Luminous intensity normalised at Permissible forward current (mA) T_a = 25 °C T_a = 25 °C 2.0 40 40 2.0 Forward current (mA) Ta = 25 °C 30 1.5 30 1.5 20 m A 1.0 20 20 1.0 10 10 0.5 0.5 0 0.0 0 0.0 2.1 2.3 2.5 -40 -20 0 20 40 60 80 100 -40 -20 0 20 40 60 80 100 1.5 1.7 1.9 0 10 20 30 40 50 Forward voltage (V) Ambient temperature (°C) Forward current (mA) Ambient temperature (°C)



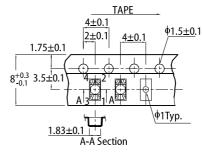
Spec No: DSAF7772 / 1203004354 Rev No: V.14A Date: 10/06/2021

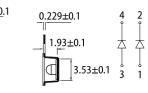
KPTBD-3216SURKCGKC

REFLOW SOLDERING PROFILE for LEAD-FREE SMD PROCESS

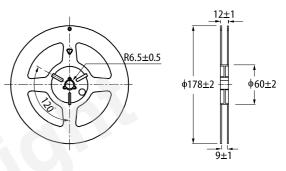


TAPE SPECIFICATIONS (units : mm)





REEL DIMENSION (units : mm)





S/N: XXXX CODE: XX

COUNTRY: CN

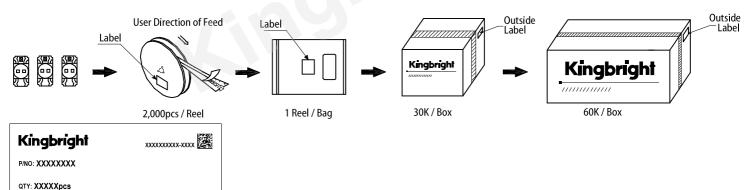
(SP)XXXXXXXXXXX

Don't cause stress to the LEDs while it is exposed to high temperature
The maximum number of reflow soldering passes is 2 times.

3. Reflow soldering is recommended. Other soldering methods are not recommended as they might cause damage to the product.

QC DATE: XXX XX XXXX PASSED

RoHS Co



PACKING & LABEL SPECIFICATIONS

PRECAUTIONARY NOTES

- The information included in this document reflects representative usage scenarios and is intended for technical reference only. The part number, type, and specifications mentioned in this document are subject to future change and improvement without notice. Before production usage customer should refer to 2. the latest datasheet for the updated specifications.
- When using the products referenced in this document, please make sure the product is being operated within the environmental and electrical limits specified in the datasheet. If 3.
- when using the products referenced in this occurrent, please make sure the product is being operated within the environmental and electrical limits specified in the datasheet. If customer usage exceeds the specified limits, Kingbright will not be responsible for any subsequent issues. The information in this document applies to typical usage in consumer electronics applications. If customer's application has special reliability requirements or have life-threatening liabilities, such as automotive or medical usage, please consult with Kingbright representative for further assistance. The contents and information of this document may not be reproduced or re-transmitted without permission by Kingbright. 4.
- 5 6.
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